

# 1MBI200NK-060

IGBT Module

## 600V / 200A Chopper Module

### ■ Features

- High speed switching
- Low inductance module structure
- Suitable for Chopper circuit

### ■ Applications

- Uninterruptible power supply
- Inverter for Motor drive



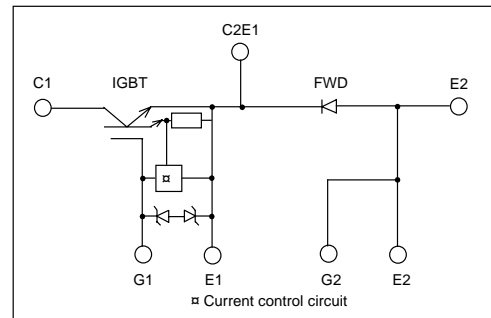
### ■ Maximum ratings and characteristics

#### ● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit		
IGBT	Collector-Emitter voltage	V <sub>CES</sub>	600	V	
	Gate-Emitter voltage	V <sub>GES</sub>	±20	V	
	Collector current	Continuous	I <sub>C</sub>	200	A
		1ms	I <sub>C pulse</sub>	400	A
	Max. power dissipation	P <sub>C</sub>	780	W	
FWD	Repetitive peak dissipation	V <sub>RRM</sub>	600	V	
	Forward current	I <sub>F</sub>	200	A	
		1ms	I <sub>F pulse</sub>	400	A
Operating temperature	T <sub>J</sub>	+150	°C		
Storage temperature	T <sub>stg</sub>	-40 to +125	°C		
Isolation voltage	V <sub>is</sub>	AC 2500 (1min.)	V		
Screw torque	Mounting *1	3.5	N·m		
	Terminals *1	3.5	N·m		

\*1 : Recommendable value : 2.5 to 3.5 N·m (M5)

### ■ Equivalent Circuit Schematic



#### ● Electrical characteristics (at Tj=25°C unless otherwise specified)

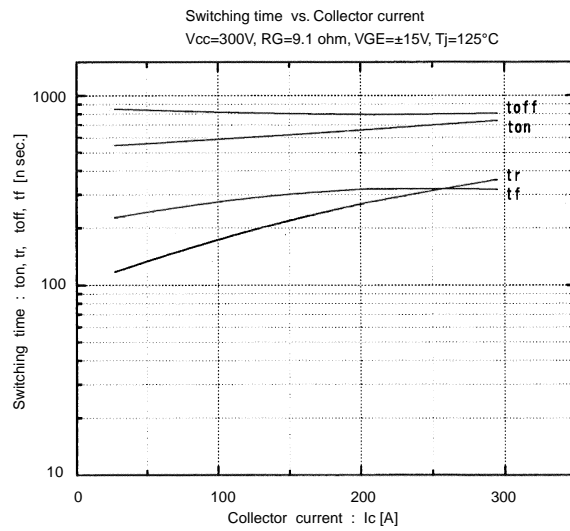
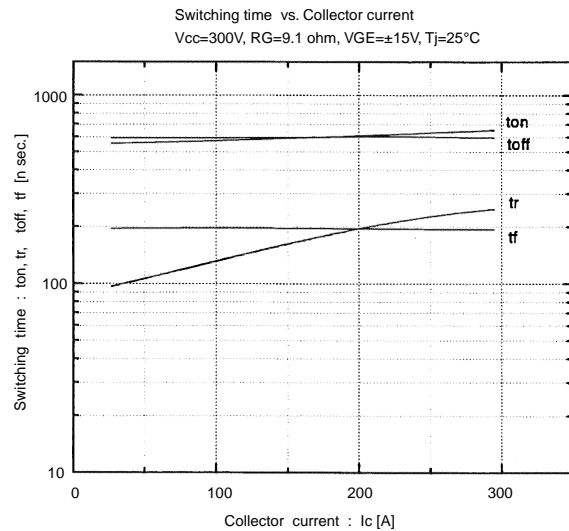
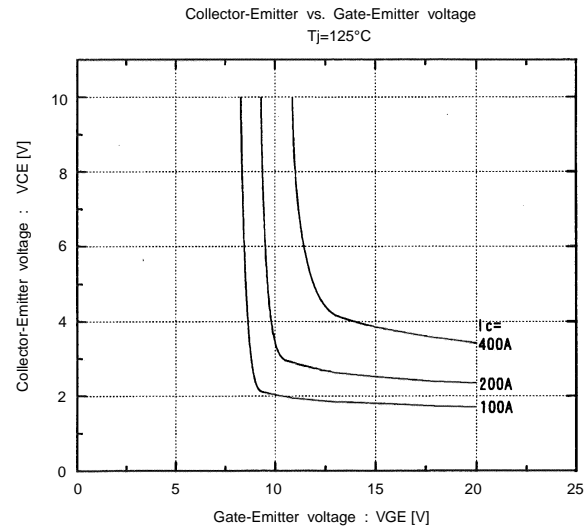
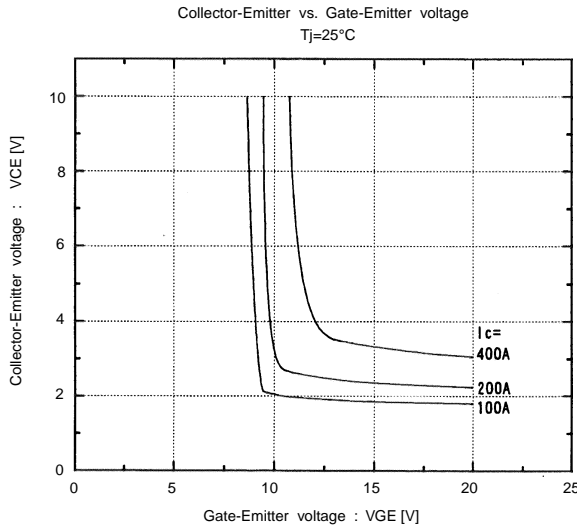
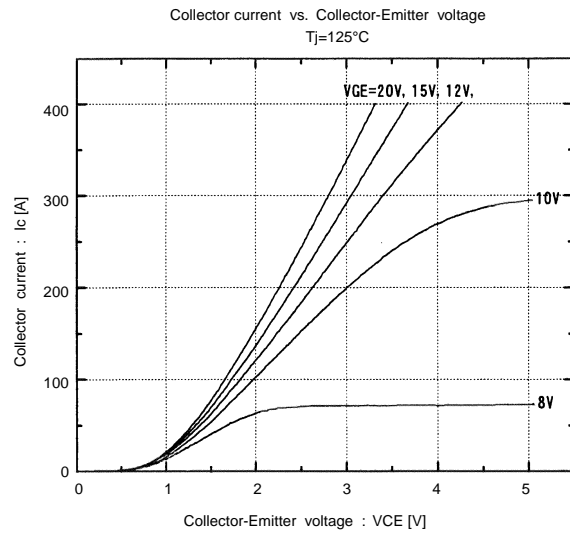
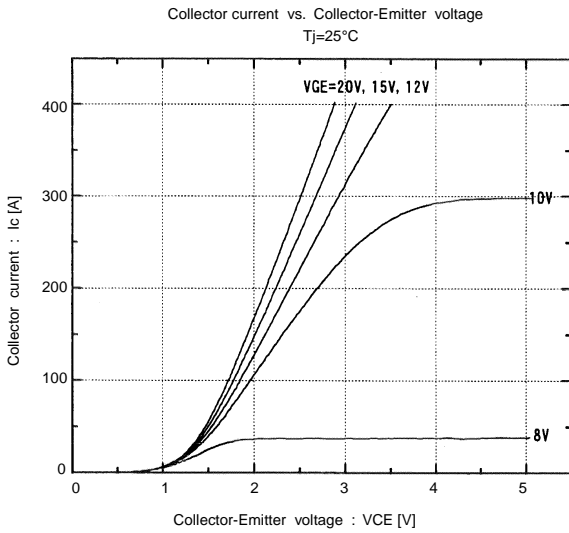
Item	Symbol	Characteristics			Conditions	Unit	
		Min.	Typ.	Max.			
IGBT	Zero gate voltage collector current	I <sub>CEs</sub>	-	-	2.0	V <sub>GE</sub> =0V, V <sub>CES</sub> =600V	mA
	Gate-Emitter leakage current	I <sub>GES</sub>	-	-	30	V <sub>CES</sub> =0V, V <sub>GES</sub> =±20V	μA
	Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	4.5	-	7.5	V <sub>CES</sub> =20V, I <sub>C</sub> =200mA	V
	Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	-	-	2.8	V <sub>GE</sub> =15V, I <sub>C</sub> =200A	V
	Input capacitance	C <sub>ies</sub>	-	13200	-	V <sub>GE</sub> =0V	pF
	Output capacitance	C <sub>oes</sub>	-	2930	-	V <sub>CES</sub> =10V	
	Reverse transfer capacitance	C <sub>res</sub>	-	1330	-	f=1MHz	
	Turn-on time	t <sub>on</sub>	-	0.6	1.2	V <sub>CC</sub> =300V	μs
			-	0.2	0.6	I <sub>C</sub> =200A	
Turn-off time		t <sub>off</sub>	-	0.6	1.0	V <sub>GE</sub> =±15V	
		t <sub>f</sub>	-	0.2	0.35	R <sub>G</sub> =9.1ohm	
FWD	Diode forward on voltage	V <sub>F</sub>	-	-	3.0	I <sub>F</sub> =200A, V <sub>GE</sub> =0V	V
	Reverse recovery time	t <sub>rr</sub>	-	-	0.3	I <sub>F</sub> =200A	μs
	Reverse current	I <sub>RRM</sub>	-	-	2.0	V <sub>R</sub> =600V	mA

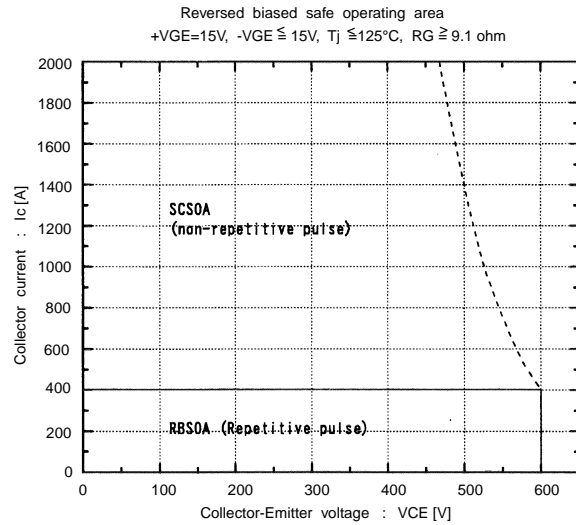
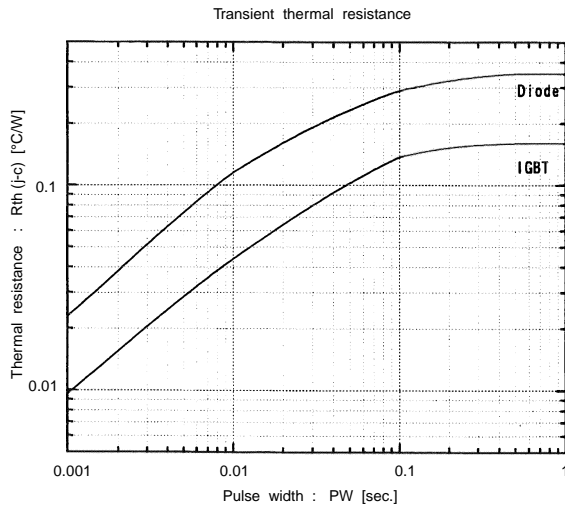
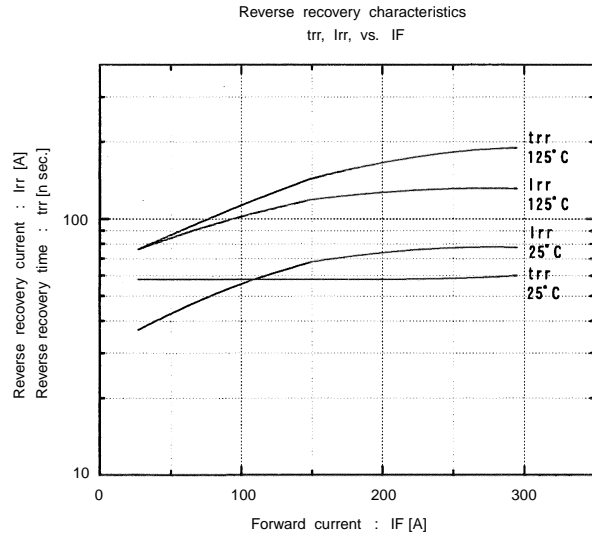
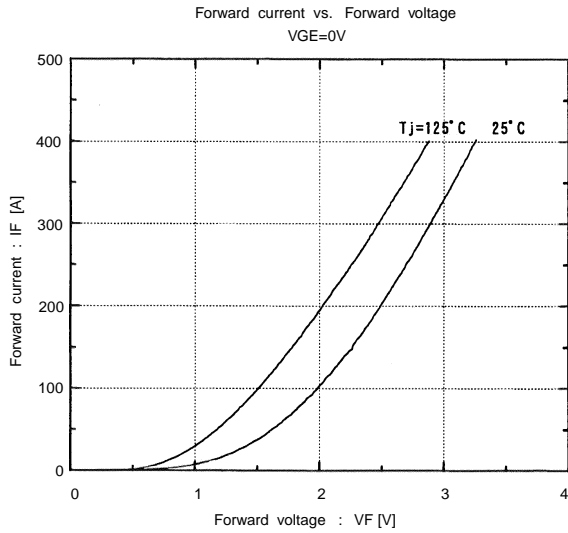
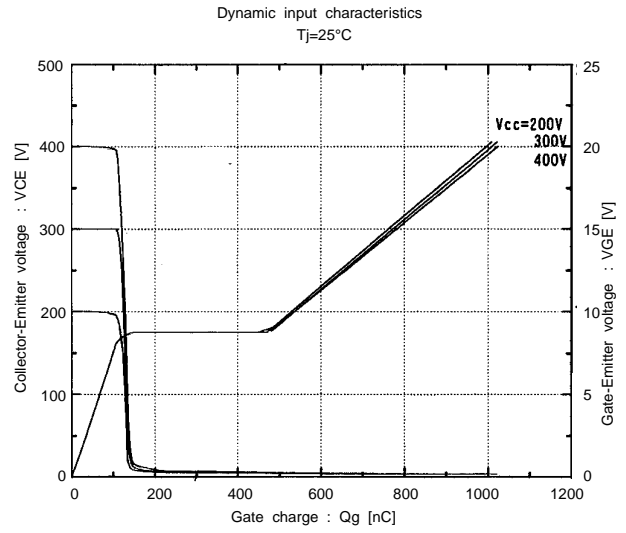
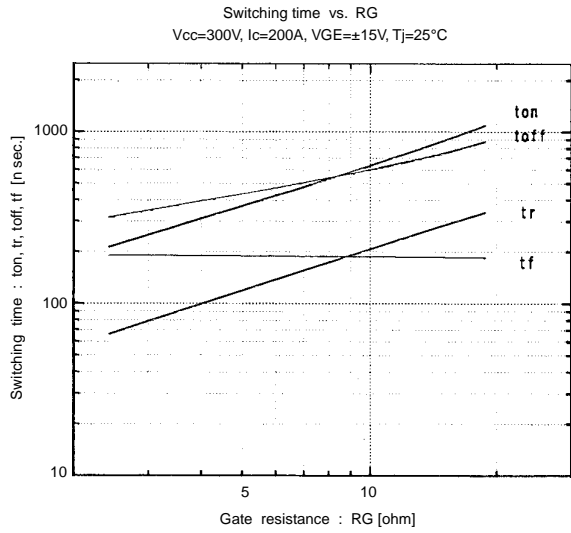
#### ● Thermal resistance characteristics

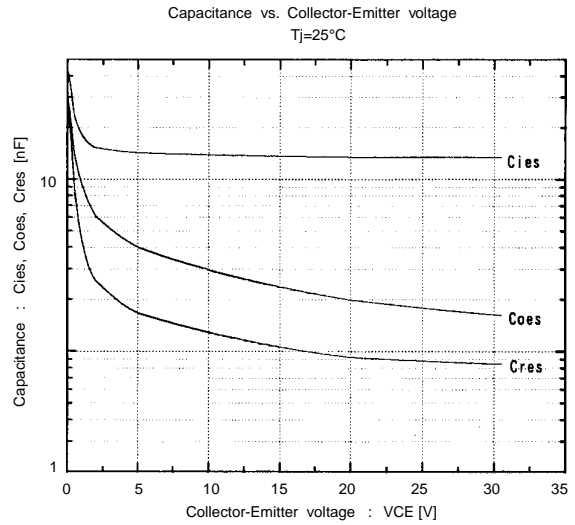
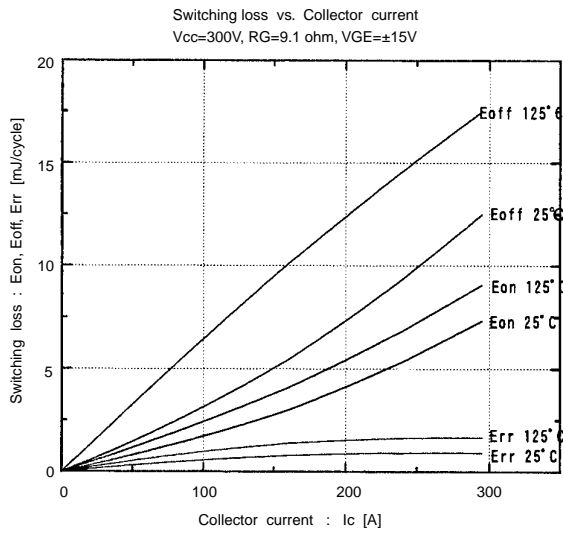
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R <sub>th(j-c)</sub>	-	-	0.16	IGBT	°C/W
	R <sub>th(j-c)</sub>	-	-	0.35	FWD	°C/W
	R <sub>th(c-f)*2</sub>	-	0.025	-	the base to cooling fin	°C/W

\*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound

■ Characteristics (Representative)







■ Outline Drawings, mm

